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RF360 Europe GmbH

Preliminary data sheet

SAW Tx filter M2M LTE band 72

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1 Application

- Low-loss SAW Tx filter for LTE Band 72 systems
- Usable pass band 5MHz

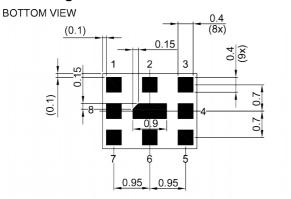
2 Features

- Package size 2.5±0.1 mm × 2.0±0.1 mm
- Package height 0.53 mm (max.)
- Approximate weight 9 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL3)



Figure 1: Picture of component with example of product marking.

3 Package

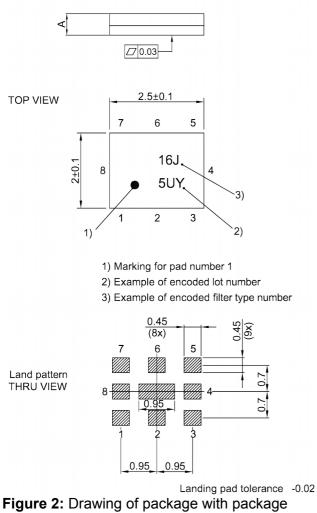


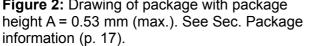
Pad and pitch tolerance ±0.05

4 Pin configuration

- 3 Output
- 8 Input
- 1, 2, 4, 5, Ground 6, 7, 9

SIDE VIEW







5 Matching circuit

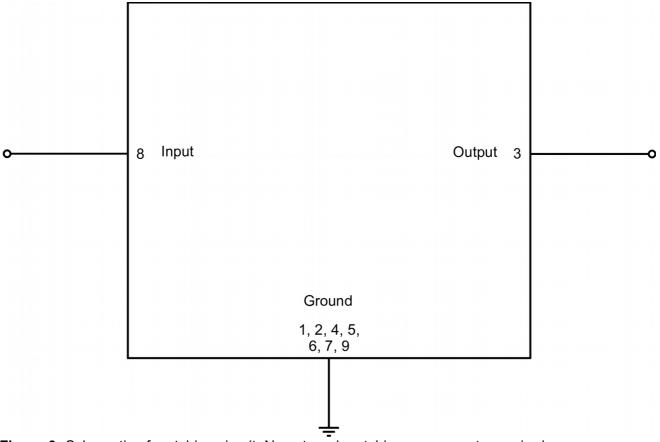


Figure 3: Schematic of matching circuit. No external matching components required.

6 Characteristics

Temperature range for specification	$T_{_{ m SPEC}}$	= −30 °C +85 °C
Input terminating impedance	Z _{IN}	= 50 Ω
Output terminating impedance	Z _{OUT}	= 50 Ω

Characteristics				min. for $T_{\rm SPEC}$	typ. @ +25 °C	max. for T _{SPEC}	
Center frequency			f _c	—	453.5	—	MHz
Maximum insertion attenuation			$\alpha_{_{max}}$				
	451 456	MHz			1.5	2.3	dB
Amplitude ripple (p-p)			Δα				
	451 456	MHz		—	0.4	1.2	dB
Maximum VSWR			$VSWR_{max}$				
@ input port	451 456	MHz			1.7	2.1	
@ output port	451 456	MHz		—	1.7	2.1	
Minimum attenuation			$\alpha_{_{min}}$				
	50 430	MHz		25	28	_	dB
	430 446	MHz		24	27	—	dB
	461 466	MHz		32	40	_	dB
	480 1100	MHz		25	28	—	dB
	1200 1500	MHz		25	30	—	dB
	1500 1600	MHz		28	31	—	dB
	1600 4000	MHz		20	32	—	dB

7 **Maximum ratings**

Operable temperature	<i>T</i> _{OP} = -40 °C +85 °C	
Storage temperature	$T_{\rm STG}$ = -40 °C +85 °C ¹)	
DC voltage	$ V_{\rm DC} = 0 V^{2}$	
ESD voltage	V _{ESD}	
	150 V ³⁾	Machine model.
	250 V ⁴⁾	Human body model.
Input power @ input port: 451 456 MHz	$P_{\rm IN}$ = t.b.d. dBm ⁵⁾	Continuous wave for 5000 h @ 55 °C. Source and load impedance 50Ω .

1) Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C.

2) In case of applied DC voltage blocking capacitors are mandatory.

3) According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses.

4)

According to JESD22-A114F (HBM – Human Body Model), 1 negative & 1 positive pulse. Expected lifetime according to accelerated power durability simulation, and wear out models. Target is 29dBm, to be 5) confirmed through hardware test.



8 Transmission coefficient

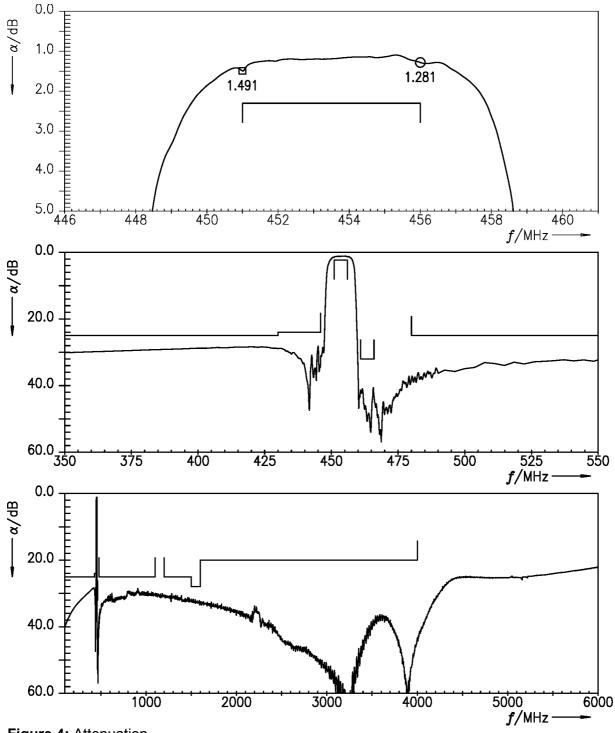


Figure 4: Attenuation.



□ = 451.0 O = 456.0

*Z*_{IN}=50 Ω

9 Reflection coefficients

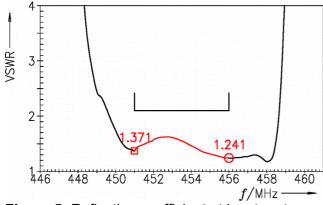


Figure 5: Reflection coefficient at input port.

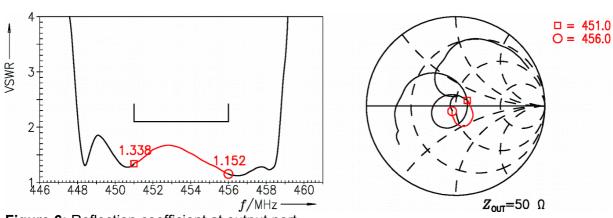
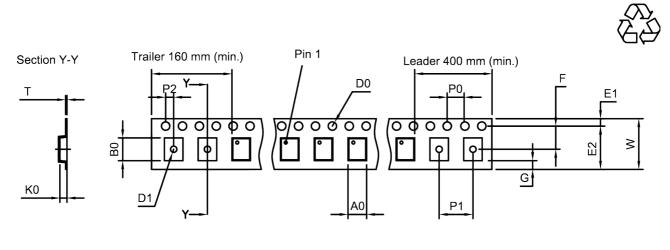


Figure 6: Reflection coefficient at output port.



10 Packing material

10.1 Tape



User direction of unreeling

Figure 7: Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

 A₀
 2.25±0.05 mm

 B₀
 2.75±0.05 mm

 D₀
 1.5±0.1/-0 mm

 D₁
 1.0 mm (min.)

 E₁
 1.75±0.1 mm

Table 1: Tape dimensions.

E2	6.25 mm (min.)
F	3.5±0.05 mm
G	0.75 mm (min.)
K ₀	0.6±0.05 mm
P ₀	4.0±0.1 mm

P ₁	4.0±0.1 mm
P ₂	2.0±0.05 mm
Т	0.25±0.03 mm
W	8.0+0.3/-0.1 mm



10.2 Reel with diameter of 180 mm

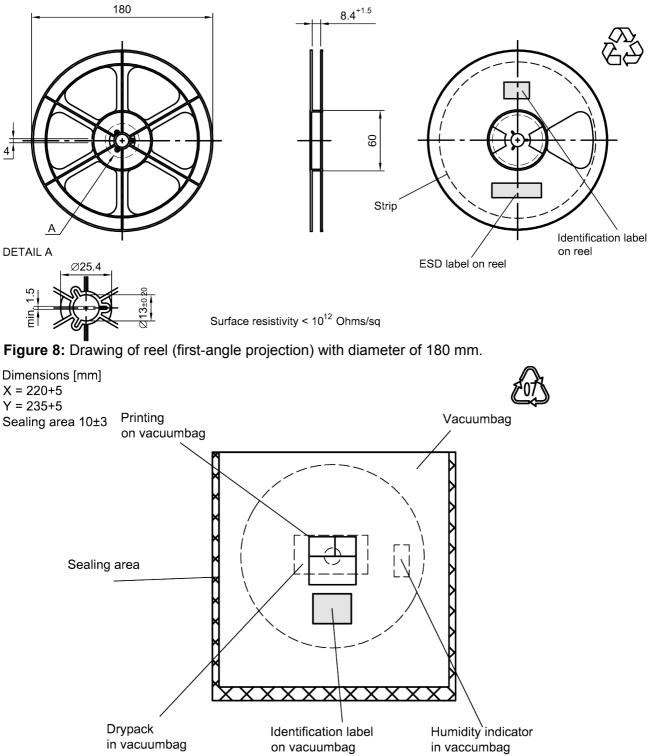


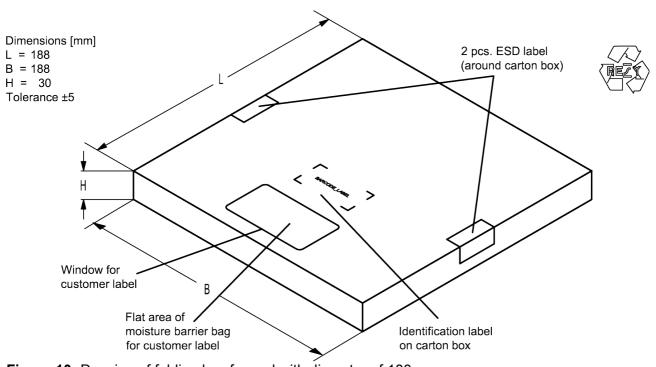
Figure 9: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

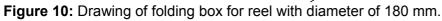
Please read **Cautions and warnings** and **Important notes** at the end of this document.

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11 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the ordering code, is encoded by a special BASE32 code into a 3 digit marking.		e.g., B3xxxxB <u>1234</u> xxxx,	
Example of decoding ty 16J 1 x 32^2 + 6 x 32^1 The BASE32 code for produ		in decimal code 1234 1234	•

■ Lot number:

The last 5 digits of the lot number, 12345, e.g., are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device **5UY**

decoding lot number marking on device		in decimal code.
5UY	=>	12345
5 x 47 ² + 27 (=U) x 47 ¹ + 31 (=Y) x 47 ⁰	=	12345

Adopted BASE32 code for type number			
Decimal	Base32	Decimal	Base32
value	code	value	code
0	0	16	G
1	1	17	Н
2	2	18	J
3	3	19	K
4	4	20	М
5	5	21	N
6	6	22	Р
7	7	23	Q
8	8	24	R
9	9	25	S
10	A	26	Т
11	В	27	V
12	С	28	W
13	D	29	Х
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal value	Base47 code	Decimal value	Base47 code
0	0	24	R
1	1	25	S
2	2	26	Т
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	X
7	7	31	Y
8	8	32	Z
9	9	33	b
10	A	34	d
11	В	35	f
12	С	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	Н	41	١
18	J	42	?
19	K	43	{
20	L	44	}
21	М	45	<
22	N	46	>
23	Р		

Table 2: Lists for encoding and decoding of marking.

12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
<i>T</i> > 220 °C	30 s to 70 s
<i>T</i> > 230 °C	min. 10 s
<i>T</i> > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

 Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

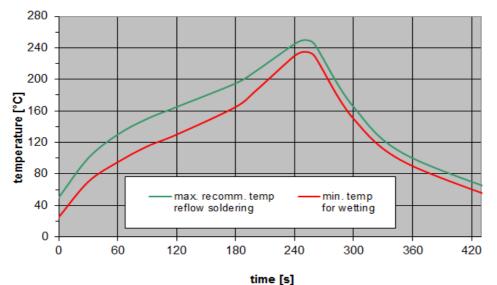


Figure 11: Recommended reflow profile for convection and infrared soldering – lead-free solder.

13 Annotations

13.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

13.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

14 Cautions and warnings

14.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under https://rffe.qualcomm.com/.

14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

14.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Projection method

Unless otherwise specified first-angle projection is applied.

15 Revision history

Changes compared to previously issued iteration.

Version	Detailed specification changes	Date
0.1	Initial Design goal. AX49_v0.1.	Nov 20, 2019
0.2	Update power durability for 5khrs@85deg.	Dec 10, 2019
1.0	Pilot run B8703.	May 20, 2020



16 Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
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